

ACM3-5036-A1-CC-S Specification

1. Features and Application

This product is for 2.4/5 GHz Dual Band WiFi, 802.11 a/b/g/n, Zigbee, Bluetooth,...

2. Explanation of Part Number

AC M3 - 5036 - A1 - CC - S ̄
 (1) (2) (3) (4) (5) (6) (7)

- (1) Product Type: Chip Antenna
- (2) Center Frequency/Band Code: 2.4/5 GHz Dual Band
- (3) Size Code: 5.0*3.6 mm (Length*Width)
- (4) Design Revision Code: Rev. 1
- (5) Antenna Type: Coupling Ceramics
- (6) Special Code: RoHS Compliant
- (7) Suffix For Special Requirements

3. Electrical Specification

Item	Specification	
Frequency Band	2400 ~ 2500 MHz	5000 ~ 6000 MHz
Polarization	Linear	
Impedance	50 ohm Typ.	
VSWR	Less than 2.0	Less than 2.0
*Peak Gain	3.0 dBi Typ.	3.3 dBi Typ.
*Peak Efficiency	73.4% Typ.	80.2% Typ.

* Test condition: Test board size 80*40 mm
 Matching circuit may be required

UNLESS OTHER SPECIFIED TOLERANCES ON :

X=± X.X=± X.XX=
 ANGLES=± HOLEDIA=±



INPAQ TECHNOLOGY CO., LTD.

SCALE : -----

UNIT : mm

DRAWN BY : 宇恩佐 *Enzo*

CHECKED BY : 趙彥年 *Oliver*

DESIGNED BY : 黃啓傑 *Tommy*

APPROVED BY : 蘇志銘 *Jim*

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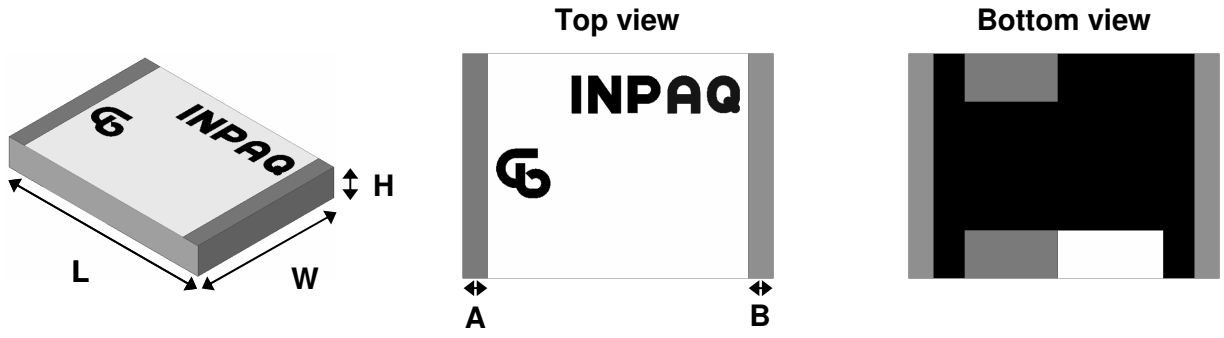
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4. Physical Dimension



Marking is Black

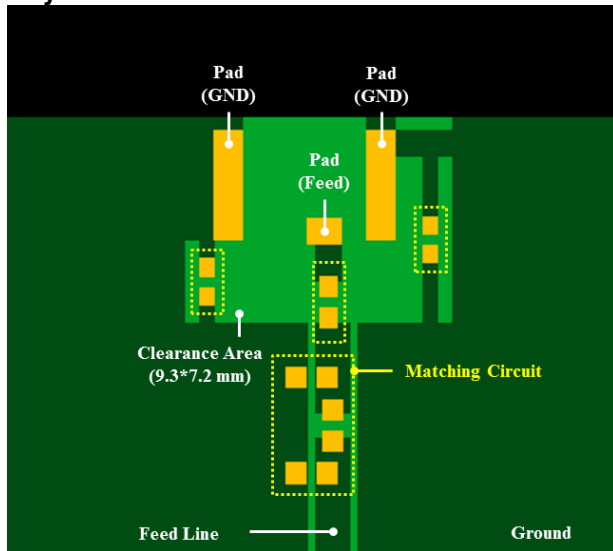
L	5.20 ± 0.30
W	3.70 ± 0.30
H	0.70 ± 0.15
A	0.45 ± 0.25
B	0.45 ± 0.25
L1	1.10 ± 0.20
W1	0.55 ± 0.20

(Unit: mm)

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DESIGNED BY : 黃啓傑 Tommy	APPROVED BY : 蘇志銘 J-m	
TITLE : ACM3-5036-A1-CC-S Specification	DOCUMENT NO.	ENS000062410 SPEC REV. A0

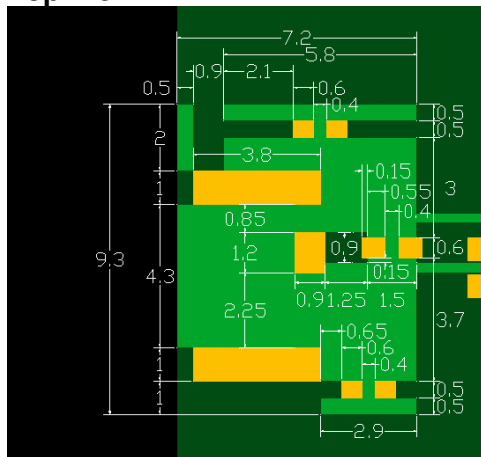
5. Recommend PCB Layout

Layout

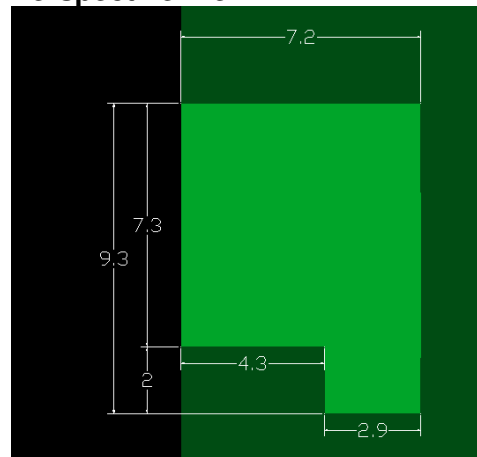


Pad Dimensions on PCB Layout


Top View



Perspective View

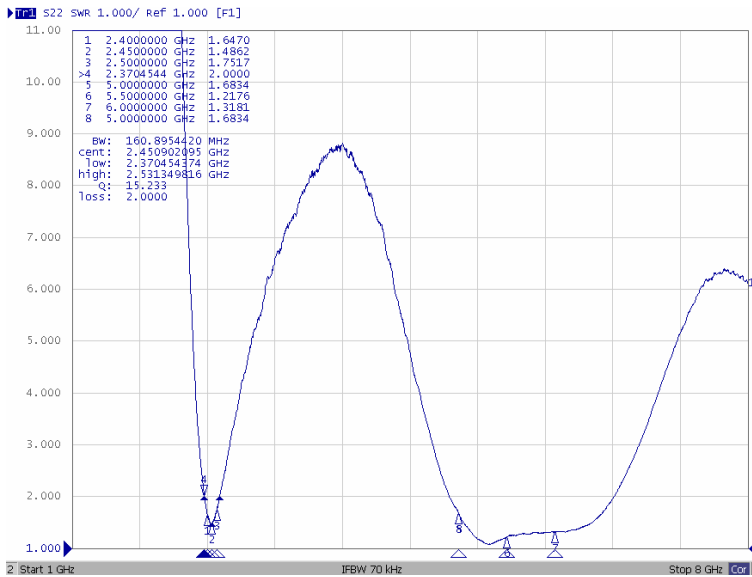


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DRAWN BY : 宇恩佐 Enzo	CHECKED BY : 趙彥年 Chen		
DESIGNED BY : 黃啓傑 Tommy	APPROVED BY : 蘇志銘 Jerry		
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6. Electrical Characteristics

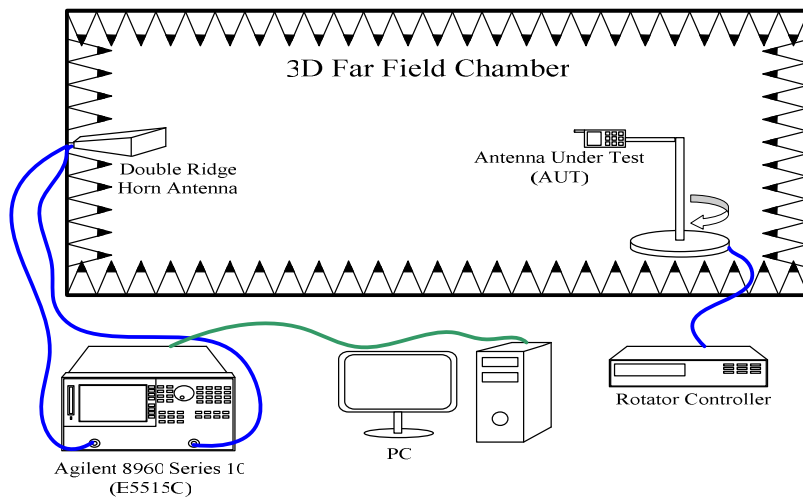
VSWR




Frequency (MHz)	VSWR
2400	1.7
2450	1.5
2500	1.7
5000	1.7
5500	1.2
6000	1.3

Radiation Pattern

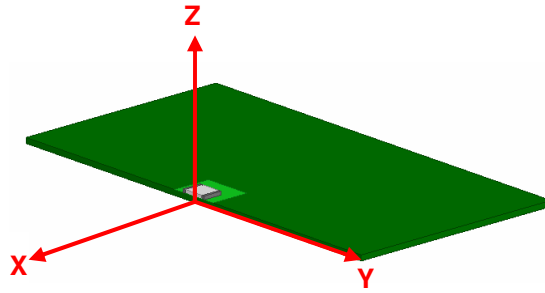
The Gain pattern is measured in INPAQ's FAR-field chamber. DUT is placed on the table of rotator, a standard horn antenna and Vector Network Analyzer is used to collect data.



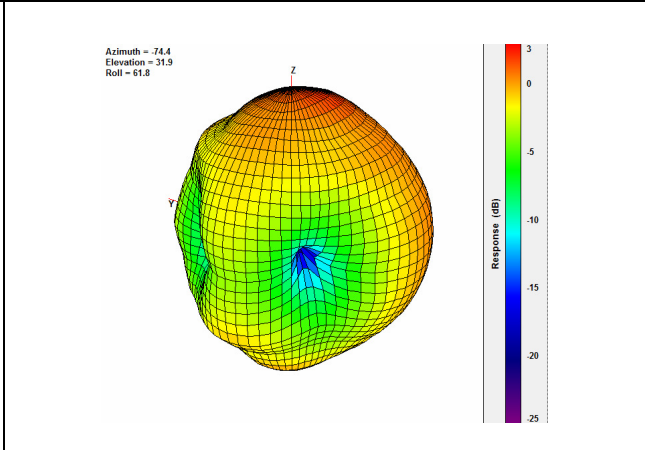
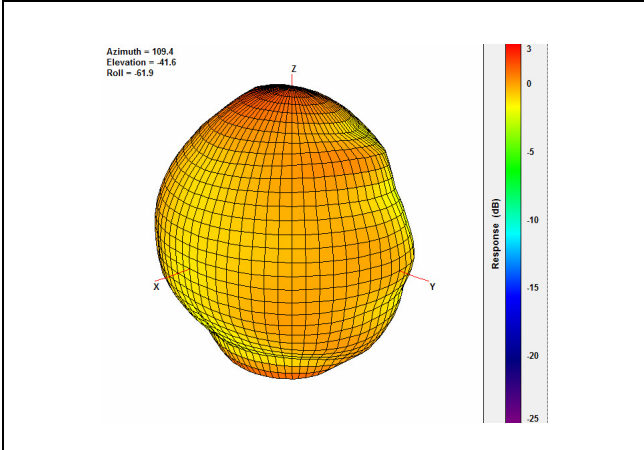
3D Chamber Definition

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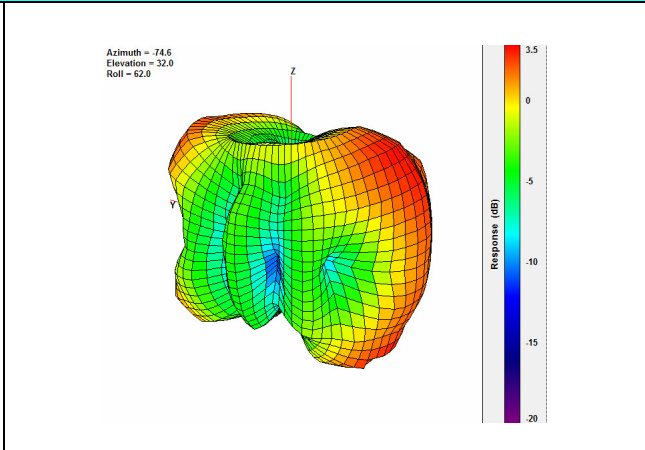
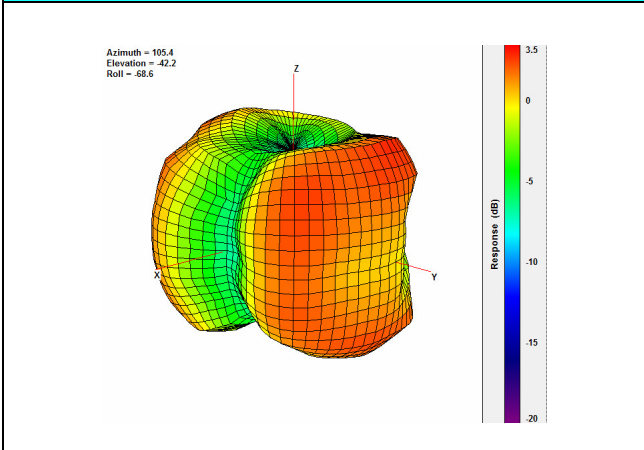
3D Gain Pattern



2450 MHz

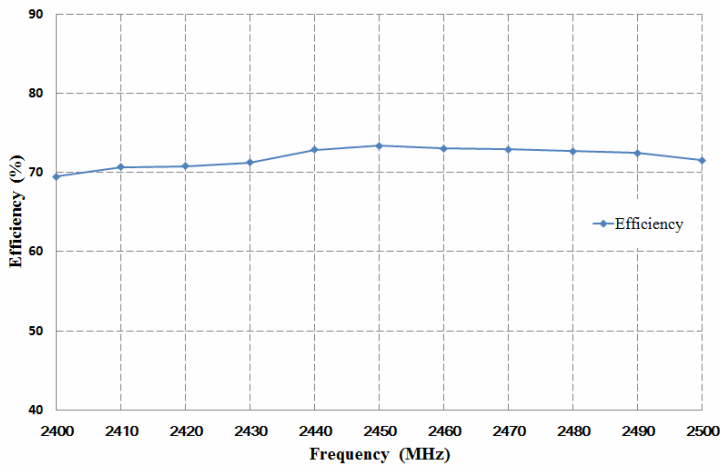


5500 MHz

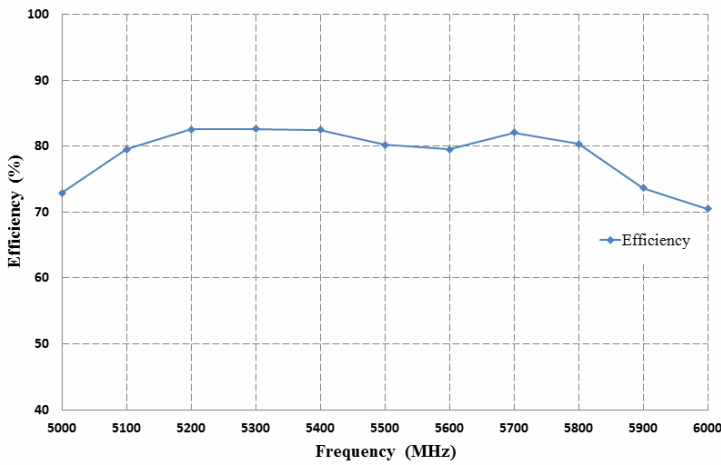


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		A0	

Efficiency



Frequency (MHz)	Efficiency (%)
2400	69.5
2450	73.4
2500	71.5
5000	72.9
5500	80.2
6000	70.5



UNLESS OTHER SPECIFIED TOLERANCES ON :

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 ANGLES=± HOLEDIA=±



INPAQ TECHNOLOGY CO., LTD.

SCALE : -----

UNIT : mm

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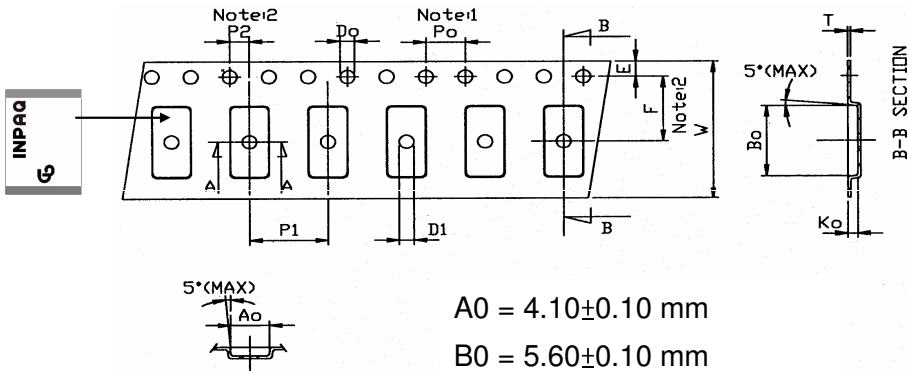
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7. Taping Package and Label Marking

- (1) Quantity/Reel: 2000pcs/Reel
- (2) Carrier tape dimensions

(Unit: mm)



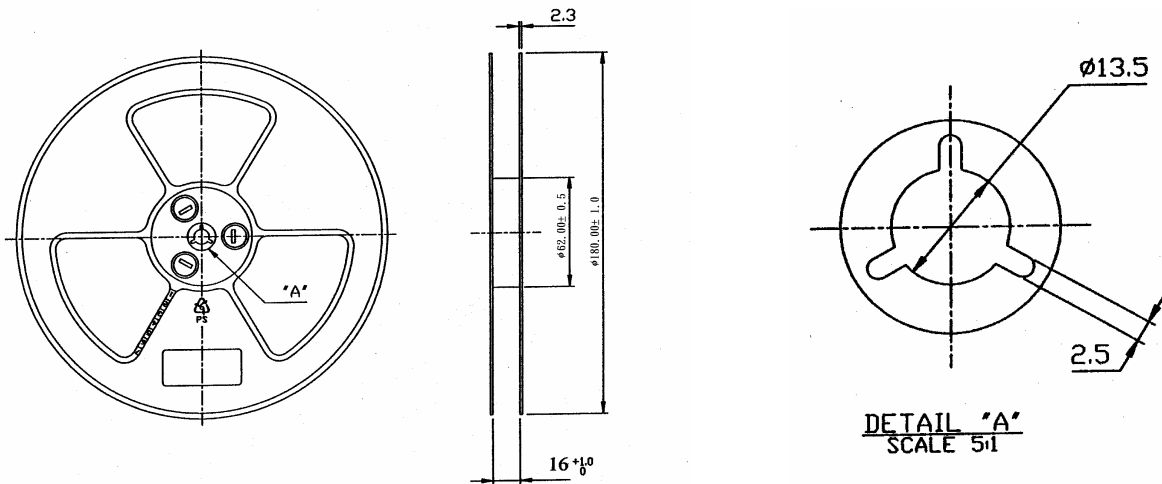
Symbol	Spec.
Po	4.00±0.1
P1	8.00±0.1
P2	2.00±0.05
Do	1.55±0.05
D1	1.50(MIN)
E	1.75±0.1
F	5.50±0.05
10Po	40.00±0.2
W	12.00±0.1
T	0.25±0.05

A0 = 4.10±0.10 mm
 B0 = 5.60±0.10 mm
 K0 = 1.02±0.10 mm

Notice:

- 10 Sprocket hole pitch cumulative tolerance is ±0.1mm
- Packet position relative to sprocket hole measured as true position of pocket not pocket hole.
- Ao & Bo measured on a plane 0.3mm above the bottom of the pocket to top surface of the carrier.
- Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
- Carrier camber shall be not than 1mm per 100mm through a length of 250mm.

(3) Taping reel dimensions



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SCALE : ----- UNIT : mm

DRAWN BY : 宇恩佐 Enzo CHECKED BY : 趙彥年 Dyan

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8. Environmental Characteristics

(1) Reliability Test

Item	Condition	Specification
Thermal shock	1. 30±3 minutes at -40°C±5°C, 2. Convert to +105°C (5 minutes) 3. 30±3 minutes at +105°C±5°C, 4. Convert to -40°C (5 minutes) 5. Total 100 continuous cycles	No apparent damage Fulfill the electrical spec. after test.
Humidity resistance	1. Humidity: 85% R.H. 2. Temperature: 85±5°C 3. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
High temperature resistance	1. Temperature: 150°C±5°C 2. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
Low temperature resistance	1. Temperature: -40°C±5°C 2. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
Soldering heat resistance	1. Solder bath temperature: 260±5°C 2. Bathing time: 10±1 seconds	No apparent damage
Solderability	The dipped surface of the terminal shall be at least 95% covered with solder after dipped in solder bath of 245±5°C for 3±1 seconds.	No apparent damage

(2) Storage condition

(a) At warehouse:


The temperature should be within 0 ~ 30°C and humidity should be less than 60% RH.
The product should be used within 1 year from the time of delivery.

(b) On board:

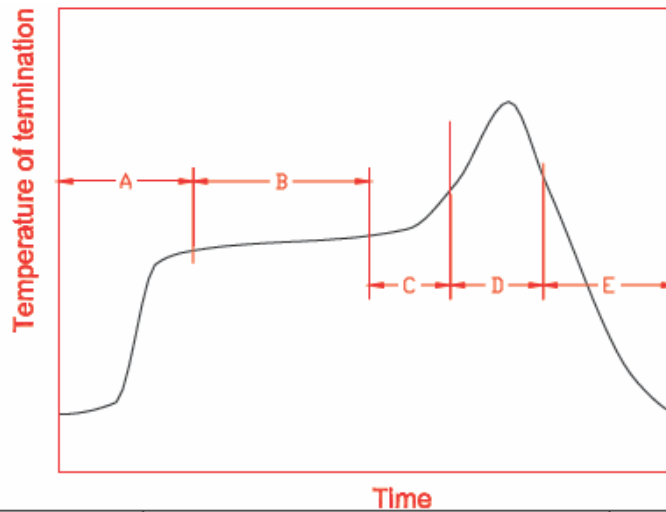
The temperature should be within -40 ~ 85°C and humidity should be less than 85% RH.

(3) Operating temperature range

Operating temperature range: -40 ~ +105°C.

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9. Recommended reflow soldering



		Time	
A	1 st rising temperature	The normal to Preheating temperature	30s to 60s
B	Preheating	140°C to 160°C	60s to 120s
C	2 nd rising temperature	Preheating to 200°C	20s to 40s
D	Main heating	if 220°C	50s~60s
		if 230°C	40s~50s
		if 240°C	30s~40s
		if 250°C	20s~40s
		if 260°C	20s~40s
E	Regular cooling	200°C to 100°C	1°C/s ~ 4°C/s

(1) Soldering gun procedure

Note the follows, in case of using solder gun for replacement.

- (a) The tip temperature must be less than 350°C for the period within 3 seconds by using soldering gun under 30 W.
- (b) The soldering gun tip shall not touch this product directly.

(2) Soldering volume

Note that excess of soldering volume will easily get crack the body of this product.

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 ANGLES=± HOLEDIA=±



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DRAWN BY : 宇恩佐 Enzo CHECKED BY : 趙彥年 Dikenn

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